

PRODUCT SELECTION GUIDE



| Item | Grade Item | Thermal Conductivity | Hardness (shoreoo) | Item | Grade Item | Thermal Conductivity | Hardness (shoreoo) |
|------|------------------|-------------------------|-----------------------|------|--------------|-------------------------|-----------------------|
| 1 | EVSF100 | 1.5w/mk | 65 | 19 | EVSC1000FG | 3.5w/mk | 90 |
| 2 | EVSF500 | 3.0w/mk | 65 | 20 | EVSF100 | 1.5w/mk | 50 |
| 3 | EVSF600 | 5.0w/mk | 50 | 21 | EVSF100FG | 1.5w/mk | 70 |
| 4 | EVSF600G | 6.0w/mk | 65 | 22 | EVSF100FG-A1 | 1.5w/mk | 90 |
| 5 | EVSF800 | 8.0w/mk | 65 | 23 | EVSF300 | 2.0w/mk | 60 |
| 6 | EVSF1000 | 10.0w/mk | 65 | 24 | EVSF400 | 2.5w/mk | 60 |
| 7 | EVSF1200 | 12.0w/mk | 65 | 25 | EVSF500 | 3.0w/mk | 75 |
| 8 | EVAF800 | 8.0w/mk | 65 | 26 | EVSF600 | 5.0w/mk | 75 |
| 9 | EVAF100 | 1.5w/mk | 75 | 27 | EVSF600G | 6.0w/mk | 80 |
| 10 | EVAF500 | 3.0w/mk | 75 | 28 | EVSF800 | 8.0w/mk | 80 |
| 11 | EVAF600G | 6.0w/mk | 75 | 29 | EVSH600 | <0.1w/mk | 20 |
| 12 | EVAF800 | 8.0w/mk | 75 | 30 | EVSP205A | 1.0w/mk | ** |
| 13 | EVSA408FG | >0.2w/mk | ** | 31 | EVSP350P | 1.8w/mk | ** |
| 14 | EVSC800FG | 0.8w/mk | 45 | 32 | EVSR600-A-B | 1500w/mk | ** |
| 15 | EVSC800-PI-2-K6 | 1.1w/mk | 90 | 33 | EVSR600-A-P | 1500w/mk | ** |
| 16 | EVSC800-PI-2-K10 | 1.3w/mk | 90 | 34 | EVCSF25 | 25w/mk | ** |
| 17 | EVSC900FG | 2.0w/mk | 45 | 35 | EVSU010-1/2 | 400w/mk | ** |
| 18 | EVSC900FG-A1 | 2.0w/mk | 45 | 36 | EVSY300 | 0.018w/mk | ** |

Updated: 10/3/2023



Product Description

CR Technology offers a wide variety of thermally conductive pads also known as gap fillers. These materials are available in both silicone and non-silicone formulations. EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness options to easily solve any heat related issue. EVERTHERM pads are naturally tacky and can be cut to any size or shape for easy installation. EVERTHERM pads are designed and engineered to achieve the highest level of thermal management to protect today's most advanced electronics.





Material Properties

- · High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF100

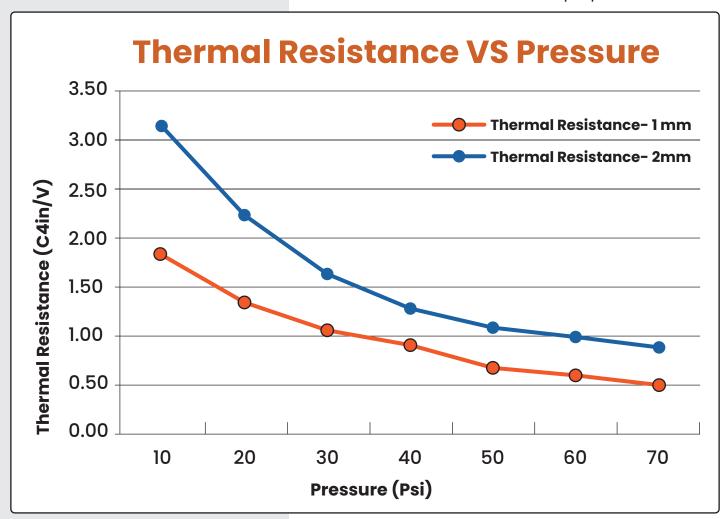
| Color | White | Visual |
|--|-------------|------------|
| Thickness | 0.15-15.0mm | ASTM D374 |
| Thermal Conductivity | 1.5 W/mK | ASTM D5470 |
| Specific Gravity | 2.1g/cc | ASTM D792 |
| Hardness (Shore OO) | 30 - 90 | ASTM D2240 |
| Elongation | 50% | ASTM D412 |
| Tensile Strength | 40psi | ASTM D412 |
| Electrical Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume Resistivity | 6*1013Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@40psi) | 0.9°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 40% | |
| Dielectric Constant MHz | 5.5 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size (Note: Other sheet sizes may be available upon reque | 200mm | x 300mm |



EVSF100

Applications

- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets





CR Technology, Inc

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Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF500

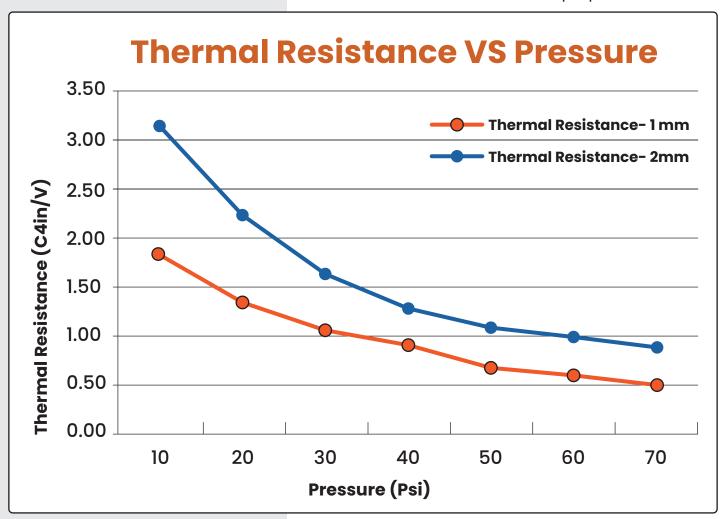
| Color | Blue | visual |
|---|-------------------------|------------|
| Thickness | 0.3 - 10mm | ASTM D374 |
| Specific Gravity | 2.9g/cc | ASTM D792 |
| Thermal Conductivity | 3.0 W/m-K | ASTM D5470 |
| Hardness (Shore OO) | 30 - 90 | ASTM D2240 |
| Elongation | 40% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Electrical Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume resistivity | 1*101 ³ Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@40psi) | 0.45°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 30% | |
| Dielectric Constant 1MHz | 7.5 | ASTM D150 |
| RoHS (10) | PASS | IEC 62321 |
| Halogen (4) | PASS | EN14582 |
| REACH (191) | PASS | EN14372 |
| Standard Sheet Size (Note: Other sheet sizes may be available upon re | 200n | nm x 300mm |



EVSF500

Applications

- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets





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Product Description

EV600 thermal pad are used for filling the two contact surfaces. They are ultra-soft and have good resilience, so effectively exclude air from the contact interface. The products are naturally tacky, can be die-cut into various shapes, easy to operate. The thermal conductivity can reach 5.0 w/m-k.





Material Properties

- · High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF600

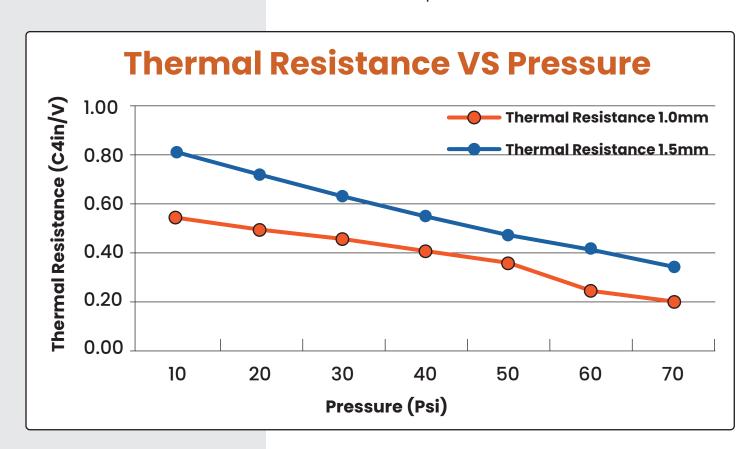
| Color | Gray | Visual |
|--|-------------------------|------------|
| Thickness | 0.5 - 5.0mm | ASTM D374 |
| Specific Gravity | 3.20g/cc | ASTM D792 |
| Thermal Conductivity | 5.0 W/m-K | ASTM D470 |
| Hardness (Shore OO) | 40-90 | ASTM D2240 |
| Elongation | 30% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Electrical Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume resistivity | 1*101 ³ Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@40psi) | 0.31°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 25% | |
| Dielectric Constant MHz | 9 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size 200 x 300mm (Note: Other sheet sizes may be available upon request.) | | |



EVSF600

Applications

- Semiconductor heat sink
- ∨ Vehicle navigator
- ✓ Communication & power equipment
- ✓ Graphics card, memory module
- ✓ LED lighting equipment
- ✓ LCD and plasma TV





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All of the above suggestions and data are from information we believe to be accurate. Although provided in good faith, we cannot provide any advice on the application of compatibility because we have no control over the conditions and methods of use of the product. Therefore, these recommendations and data are for reference only and not as a product warranty.



CR Technology offers a wide variety of thermally conductive pads also known as gap fillers. These materials are available in both silicone and non-silicone formulations.

EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness, are naturally tacky and can be cut to any size or shape for easy installation





Material Properties

- · High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVSF600G

| Color | Gray | Visual |
|--------------------------------|--------------------------|------------|
| Thickness | 0.5 - 5.0mm | ASTM D374 |
| Specific Gravity | 3.30g/cc | ASTM D792 |
| Thermal Conductivity | 6.0 W/m-K | ASTM D5470 |
| Hadness (Shore 00) | 40-90 | ASTM D2240 |
| Elongation | 30% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Electrical Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume resistivity | 1*101 ³ Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200° | |
| Thermal Resistance(1mm,@40psi) | 0.29 ^o *in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 25% | |
| Dielectric Constant MHz | 9 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size 200 x 300mm (Note: Other sheet sizes may be available upon request.)

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

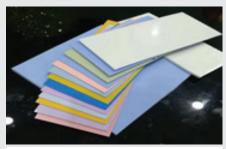
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Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF800

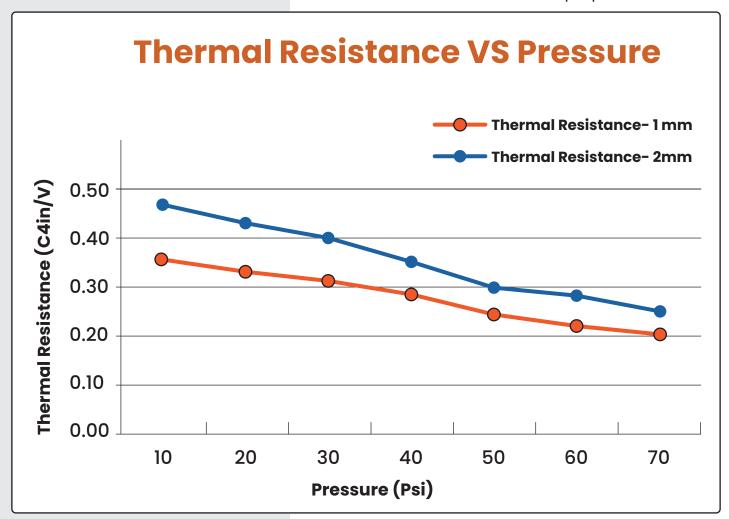
| Color | (| Gray | Visual |
|---|------------|---------------------|------------|
| Thickness | | 3.0mm | ASTM D374 |
| Specific Gravity | 3.4 | 10g/cc | ASTM D792 |
| Thermal Conductivity | 8.0 | W/m-K | ASTM D5470 |
| Hardness (Shore OO) | 4 | 40-80 | ASTM D2240 |
| Elongation | | 15% | ASTM D412 |
| Tensile Strength | 2 | 20psi | ASTM D412 |
| Dielectric Breakdown Voltage | >6KV AC/mm | | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | | E355606 |
| Volume resistivity | 1*10 | l ³ Ω.cm | ASTM D257 |
| Operating Temperature | -50 | - 200°C | |
| Thermal Resistance(1mm,@40psi) | 0.29 | C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | | 15% | |
| Dielectric Constant 1MHz | 5.5 | | ASTM D150 |
| RoHS (10) | PASS | | IEC 62321 |
| Halogen (4) | PASS | | EN14582 |
| REACH (191) | PASS | | EN14372 |
| Standard Sheet Size (Note: Other sheet sizes may be available upon it | request.) | 200 x 3 | 300mm |



EVSF800

Applications

- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like:
 LEDs, CPUs, MOS Mobiles, Laptops, Tablets





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Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF1000

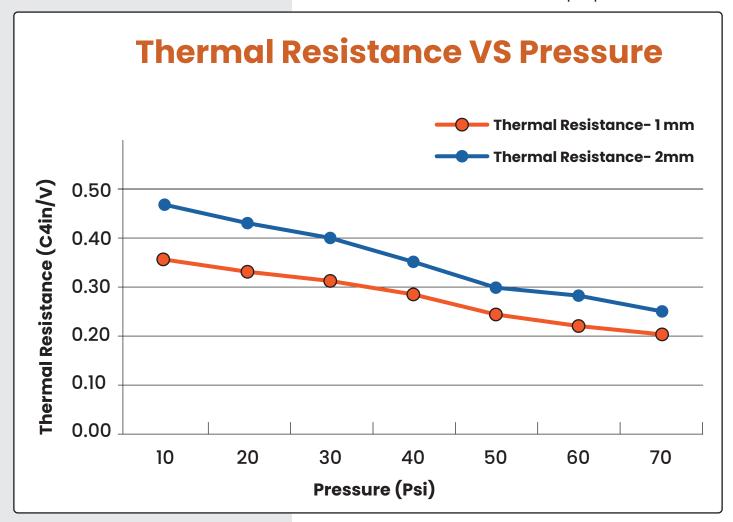
| Color | G | ray | Visual |
|--|-------------------|-------------------|------------|
| Thickness | 0.5 - ! | 5.0mm | ASTM D374 |
| Specific Gravity | 3.40 | Og/cc | ASTM D792 |
| Thermal Conductivity | 10.0 \ | W/m-K | ASTM D5470 |
| Hardness (Shore OO) | 40 | 0-80 | ASTM D2240 |
| Elongation | 1 | 5% | ASTM D412 |
| Tensile Strength | 10 | Opsi | ASTM D412 |
| Breakdown voltage strength | >6KV AC/mm | | ASTM D149 |
| UL Flammability Rating | UL9 | 4 V-0 | |
| Volume resistivity | 1*10 ¹ | ² Ω.cm | ASTM D257 |
| Operating Temperature | -50 |) - 150°C | |
| Thermal Resistance(1mm,@40psi) | 0.12% | C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 3 | 30% | |
| Dielectric Constant MHz | 12 | | ASTM D150 |
| RoHS | PASS | | IEC 62321 |
| Halogen | PASS | | EN14582 |
| REACH | PASS | | EN14372 |
| Standard Sheet Size (Note: Other sheet sizes may be available upon | request.) | 200 | x 300mm |



EVSF1000

Applications

- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like:
 LEDs, CPUs, MOS Mobiles, Laptops, Tablets

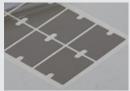




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Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVSF1200

| Color | Gray | Visual |
|--------------------------------|-------------------------|------------|
| Thickness | 0.8 - 5.0mm | ASTM D374 |
| Specific Gravity | 3.40g/cm ³ | ASTM D792 |
| Thermal Conductivity | 12.0 W/m.k | ASTM D5470 |
| Hardness(Shore oo) | 40-80 | ASTM D2240 |
| Elongation | 15% | ASTM D412 |
| Tensile Strength | 10psi | ASTM D412 |
| Breakdown Voltage Strength | >5KV AC/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume Resistivity | 1*10 ¹² Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 120℃ | |
| Thermal Resistance(1mm,@40psi) | 0.1°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | ≥15% | |
| Dielectric Constant MHz | 12.0 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |

Standard Sheet Size

200 x 300mm

(Note: Other sheet sizes may be available upon request.)

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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EverTherm non-silicone thermal pads are manufactured from an advanced resin. They will not damage or promote circuit failure and have no siloxane volatilization resulting in no silicone oil seeping. EverTherm Non Silicone pads exhibit low outgassing, excellent tensile and wear resistance.





Material Properties

- · High thermal conductivity
- · Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- *⊙* Electric Vehicle (EV) Batteries
- ✓ Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVAF800 NON-SILICONE

| Color | Light Gray | Visual |
|--------------------------------|-----------------------|------------|
| Thickness | 0.5 - 5.0mm | ASTM D374 |
| Specific Gravity | 3.4g/cm3 | ASTM D792 |
| Thermal Conductivity | 8.0 W/m.k | ASTM D5470 |
| Hardness(Shore 00) | 45-80 | ASTM D2240 |
| Elongation | 30% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Dielectric Breakdown Voltage | >8KV/mm | ASTM D149 |
| Flammability Rating | 94 V-0 | UL 94 |
| Volume Resistivity | 10 ¹³ Ω.cm | ASTM D257 |
| Operating Temperature | -40-120°C | |
| Thermal Resistance(1mm,@40psi) | 0.10°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 20% | |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |

Standard Sheet Size 200 x 300mm (Note: Other sheet sizes may be available upon request.)

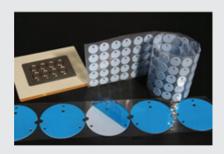
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EVAF100 non-silicone thermal gap pads are manufactured from highly Engineered resins. EVAF100 non-silicone thermal gap pads will not create circuit failure as they contain no siloxane volatilization, therefore will not promote silicone oil EVAF100 seeping. Non-Silicone thermal gap pads have excellent tensile strength and wear resistance. EverTherm Non-Silicone pads exhibit low outgassing, excellent tensile and wear resistance.



Applications

- ✓ Vehicle navigator
- ✓ Camera equipment
- ✓ Notebook computer
- Mobile and communication equipment
- Automotive engine control equipment
- High end industrial control and medical electronics



EVAF100 SILICONE FREE

| Color | White | Visual |
|--------------------------------|-----------------------|--------------|
| Thickness | 0.25 - 5.0m | nm ASTM D374 |
| Specific Gravity | 1.9g/cm | 3 ASTM D792 |
| Thermal Conductivity | 1.0 W/ml | K ASTM D547 |
| Hardness(shore oo) | 40-80 | ASTM D224 |
| Elongation | 100% | ASTM D412 |
| Tensile Strength | 75psi | ASTM D412 |
| Dielectric Breakdown Voltage | >8KV/AC/r | mm ASTM D149 |
| Flammability Rating | 94 V-0 | UL 94 |
| Volume Resistivity | 10 ¹³ Ω.cr | m ASTM D257 |
| Operating Temperature | -40 - 130° | °C |
| Thermal Resistance(1mm,@40psi) | 1.10°C*in2/ | /W ASTM D547 |
| Compression Ratio(1mm,@40psi) | 30% | |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size | | 200 v 300mm |

Standard Sheet Size 200 x 300mm (Note: Other sheet sizes may be available upon request.)

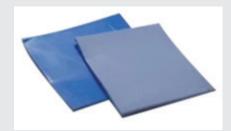
Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Applications

- ✓ Power battery pack
- ✓ Vehicle navigator
- ✓ Optical precision equipment
- ✓ Camera equipment
- ✓ Notebook computer
- Mobile and communication equipment
- Automotive engine control equipment
- High end industrial control and medical electronics



EVAF500 NON-SILICONE

| Color | Off White | Visual |
|--------------------------------|-----------------------|------------|
| Thickness | 0.25 - 5.0mm | ASTM D374 |
| Specific Gravity | 2.9g/cm3 | ASTM D792 |
| Thermal Conductivity | 3.0 W/mK | ASTM D5470 |
| Hardness(Shore oo) | 40-80 | ASTM D2240 |
| Elongation | 70% | ASTM D412 |
| Tensile Strength | 55psi | ASTM D412 |
| Dielectric Breakdown Voltage | >8KV/AC/mm | ASTM D149 |
| Flammability Rating | 94 V-0 | UL 94 |
| Volume Resistivity | 10 ¹³ Ω.cm | ASTM D257 |
| Operating Temperature | -40 - 130°C | |
| Thermal Resistance(1mm,@40psi) | 0.6°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 30% | |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |

Standard Sheet Size 200 x 300mm (Note: Other sheet sizes may be available upon request.)

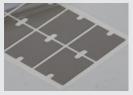
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Material Properties

- · High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVAF600G NON-SILICONE

| Color | White | Visual |
|--------------------------------|-----------------------|------------|
| Thickness | 0.5-5.0mm | ASTM D374 |
| Specific Gravity | 3.1g/cm3 | ASTM D792 |
| Thermal Conductivity | 6.0 W/m.k | ASTM D5470 |
| Hardness(shore 00) | 45-80 | ASTM D2240 |
| Elongation | 50% | ASTM D412 |
| Tensile Strength | 30Psi | ASTM D412 |
| Dielectric Breakdown Voltage | >8KV/mm | ASTM D149 |
| Flammability Rating | 94 V-0 | UL |
| Volume Resistivity | 10 ¹³ Ω.cm | ASTM D257 |
| Operating Temperature | -40 - 125°C | |
| Thermal Resistance(1mm,@40psi) | 0.25°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 20% | |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |

Standard Sheet Size
(Note: Other sheet sizes may be available upon request.)

200 x 300mm

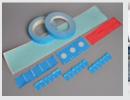
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EverTherm thermal tape is widely used in bonding heat sinks to microprocessors and power consuming semiconductors. It features a high adhesive strength and low thermal impedance, which can effectively replace silicone grease and mechanical fixation.





Material Properties

- High-strength viscosity suitable for various surfaces
- Double-sided pressure-sensitive adhesive tape
- High thermal conductive acrylic adhesive
- Can withstand long-term high temperature working environment

Applications

- ✓ LED lighting products
- Chassis, frame or other cooling components
- ✓ Large capacity drive
- ✓ Heat pipe assembly
- ✓ High frequency micro processing chip
- ✓ Notebook and desktop computers



EVSA408FG

| Color | White | Visual |
|---|-------------------------|------------|
| Substrate | Acrylic resin (Acrylic) | *** |
| Substrate reinforcement | Fiberglass | *** |
| Thickness(mm) | 0.20±0.01 | ASTM D374 |
| Dielectric Breakdown Voltageh@AC | >4000V | ASTM D149 |
| Release force | 1.8kg/25mm | PSTC-3 |
| Shear strength1.0 kg loading on 25 mm x 25 mm | > 48 hrs | PSTC-7 |
| Heat resistance0.5kg loading on25mm x 25mm at 80 | > 24 hrs | *** |
| Thermal conductivity (W/m.k) | 1.0 | ASTM D5470 |
| Operating temperature | -30 - 130 | *** |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size (Note: Other sizes may be available upon request) | 1024mmx50m | |
| | | |
| | | |
| | | |

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

CR Technology, Inc

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Product Description

EVSC800FG is made of ultra-thin fiberglass coated with thermally conductive silicone on one side. The overall total thickness is 0.1 mm and acts as a heat transfer as it breaks down voltage.



Benefits

- High thermal conductivity, low resistance
- Electrical insulation
- High pressure resistance
- High tensile strength

Applications

- ✓ Power adapter
- ✓ Automobile electronics
- ✓ Communication equipment
- ✓ Motor controllers
- Semiconductor optoelectronic products



EVSC800FG Thermal Film

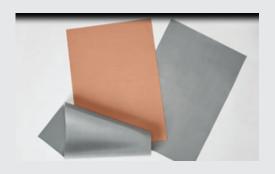
| Color | Gray | Visual |
|---|--|---------------|
| Composition | Thermal conductions silicone, glass file | |
| Thickness (mm) | 0.2-0.5mr | n ASTM D751 |
| Density (g/cc) | 2.2 | ASTM D297 |
| Hardness (Shore A) | 45 | ASTM D2240 |
| Tensile strength (MPa) | 450 | ASTM D412 |
| Operating Temperature°F/°C | (-58 to 356°F (-50 to 200°C | *** |
| Electi | rical | |
| Breakdown Voltage(AC KV/mm) | >5000 | ASTM D149 |
| Dielectric constant (1000 Hz) | 5.5 | ASTM D150 |
| Volume resistivity | 5.0 X 10 ¹³ | ASTM D257 |
| (ohm-meter) | | |
| Flame Rating | V0 | UL 94 |
| Thermal co | nductivity | |
| Thermal Conductivity(W/m-K) | 0.8 | ASTM D5470 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size 30 (Note: Other sheet sizes may be available upon request.) | | 305mm X 305mm |

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Product Description

EVSC800-PI-2-K6 is made of ultra-thin PI film and coated with thermally conductive silicone on one side. The overall total thickness is 0.16 mm and acts as a heat transfer as it breaks down voltage.



Benefits

- High thermal conductivity, low resistance
- Electrical insulation
- · High pressure resistance
- · High tensile strength

Applications

- ✓ Power adapter
- ✓ Automobile electronics
- ✓ Communication equipment
- ✓ Motor controllers
- Semiconductor optoelectronic products



EVSC800-PI-2-K6 Thermal Film

| Color | Gray | Visual |
|--|------------------------------|------------|
| Composition | PI film, thermal silicone | * * * |
| Thickness (mm) | 0.16±0.02 | ASTM D751 |
| Density (g/cc) | 2.2 | ASTM D297 |
| Hardness (Shore A) | 90±5 | ASTM D2240 |
| Tensile strength (MPa) | 35 | ASTM D412 |
| Operating Temperature°F/°C | -50 to 200°C | * * * |
| Electi | rical | |
| Breakdown Voltage(AC KV/mm) | >6000 | ASTM D149 |
| Dielectric constant (1000 Hz) | 5.0 | ASTM D150 |
| Volume resistivity | 1012 | ASTM D257 |
| (ohm-meter) | | |
| Flame Rating | V-0 | UL 94 |
| Thermal co | nductivity | |
| Thermal Conductivity(W/m-K) | 1.1 | ASTM D5470 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size (Note: Other sheet sizes may be available upon request.) 305mm x 305r | | |

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Product Description

EverTherm thermally conductive insulating pads are made of an ultra-thin Polyimide film coated with a thermally conductive silicone on both sides. The overall total thickness is 0.1 mm and acts as a heat transfer as it breaks down voltage.



Benefits

- High thermal conductivity, low resistance
- Electrical insulation
- · High pressure resistance
- · High tensile strength

Applications

- ✓ Power adapter
- ✓ Communication equipment
- ✓ Motor controllers
- Semiconductor optoelectronic products



EVSC800-PI-2-K10 Thermal Insulating Pad

| Color | Yellow | Visual | |
|--|----------------------------|---------------|--|
| Composition | PI film, thermal silico | * * * | |
| Thickness (mm) | 0.16±0.02 | 2 ASTM D751 | |
| Density (g/cc) | 2.3 | ASTM D297 | |
| Hardness (Shore A) | 90±5 | ASTM D2240 | |
| Tensile strength (MPa) | 35 | ASTM D412 | |
| Operating Temperature°F/°C | -50 to 200 |)°C *** | |
| Electrical | | | |
| Breakdown Voltage(AC KV/mm) | >6000 | ASTM D149 | |
| Dielectric constant (1000 Hz) | 3.7 | ASTM D150 | |
| Volume resistivity | 1012 | ASTM D257 | |
| (ohm-meter) | | | |
| Flame Rating | V-0 | UL 94 | |
| Thermal conductivity | | | |
| Thermal Conductivity(W/m-K) | 1.3 | ASTM D5470 | |
| RoHS | PASS | IEC 62321 | |
| Halogen | PASS | EN14582 | |
| REACH | PASS | EN14372 | |
| Standard Sheet Size 3 (Note: Other sheet sizes may be available upon request.) | | 305mm x 305mm | |

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EverTherm SC Series is a thermally conductive silicone tape offering high temperature capability and conformability. Fiberglass fabric supports the thermally conductive silicone rubber impregnation and adds dimensional stability resistance. This puncture thin material keeps thermal resistance low and save space while providing electrical isolation.



Material Properties

- Assembly time reduced by 70% over grease & mica systems
- Puncture resistance; high thermal conductivity
- Electrically isolates power sources from heat sink devices
- Resists high pressure and deterioration
- Optional Adhesive available for ease of install
- UL94V-0 flammability rating, ROHS, halogen free
- Easy to assemble

Applications

- Automotive electronics
- ✓ Adapter
- ✓ Communication equipment
- ✓ Motor Controller
- ✓ Semiconductor Optoelectronic Products



EVSC900FG

| Color | Brick Red | Visual | |
|---------------------------------|------------------------|------------|--|
| Base | Fiberglass | * * * | |
| Thickness (mm) | 0.2-0.5mm | ASTM D751 | |
| Density (g/cm³) | 2.2 | ASTM D297 | |
| Hardness (Shore A) | 45 | ASTM D2240 | |
| Tensile Strength (psi) | 450 | ASTM D412 | |
| Operating Temperature | -50 to 200℃ | * * * | |
| Electrical | | | |
| Dielectric Breakdown Voltage@AC | >4000V | ASTM D149 | |
| Dielectric constant (1MHz) | 5.5 | ASTM D150 | |
| Volume resistivity (Ω.cm) | 5.0 X 10 ¹³ | ASTM D257 | |
| Fire rating | V-0 | UL 94 | |
| Thermal conductive | | | |
| Thermal conductivity(W/m.k) | 2.0 | ASTM D5470 | |
| RoHS | PASS | IEC 62321 | |
| Halogen | PASS | EN14582 | |
| REACH | PASS | EN14372 | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

305mm x 305mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Product Description

Thermal Insulating Sheet



- Material Properties
 High thermal conductivity, low resistance
- Electrical insulation
- · High pressure resistance
- High tensile strength

Also Available:

- Cut per drawing and custom shapes
- Optional adhesive

Applications

- Automotive electronics
- ✓ Adapter
- ✓ Communication equipment
- ✓ Motor Controller
- ✓ Semiconductor Optoelectronic Products



EVSC1000FG

| lor | White |) | Vis | ual | |
|-----------------|---|--|---|---|-----|
| osition | Fiber | glass | * > | * * | |
| ss (mm) | 0.2-0. | 5mm | ASTM | D751 | |
| (Shore A) | 9 | 0 | ASTM | D2240 | |
| 10 | 25 | 50 | 100 | 200 | |
| 0.59 | 0.44 | 0.34 | 0.29 | 0.24 | |
| perature °F/ °C | -50 to 200°C | | -50 to 200°C * * * * | | * * |
| Electi | rical | | | | |
| own Voltage@AC | >40 | 00V | ASTM | D149 | |
| nstant (1MHz) | 3.0 |)~3.5 | ASTM | D150 | |
| stivity (Ω.cm) | 10 | O _{II} | ASTM | D257 | |
| Fire rating | | V0 | | 94 | |
| Thermal co | onducti | ve | | | |
| ictivity(W/m.k) | 3.5 | | ASTM | D5470 | |
| HS | PΔ | SS | IEC 6 | 32321 | |
| Halogen | | PASS | | 1582 | |
| СН | PΔ | SS | EN14 | 1372 | |
| | osition ss (mm) (Shore A) 10 0.59 perature °F/ °C Electrown Voltage@AC own Voltage@AC ostant (1MHz) stivity (Ω.cm) ating Thermal contributions activity(W/m.k) HS gen | osition Fiber os (mm) 0.2-0. (Shore A) 9 10 25 0.59 0.44 perature °F/ °C -50 to Electrical own Voltage@AC >40 astant (1MHz) 3.0 ostivity (Ω.cm) 10 ating V Thermal conduction 3 activity(W/m.k) 3 HS PA gen PA | position Fiber glass as (mm) 0.2-0.5mm (Shore A) 90 10 25 50 0.59 0.44 0.34 perature °F/ °C -50 to 200 °C Electrical own Voltage@AC >4000 V astant (1MHz) 3.0~3.5 stivity (Ω.cm) 10 ° activity (W/m.k) 3.5 HS PASS gen PASS | sition Fiber glass ** ss (mm) 0.2-0.5mm ASTM (Shore A) 90 ASTM 10 25 50 100 0.59 0.44 0.34 0.29 Electrical own Voltage@AC >4000V ASTM stivity (Ω.cm) 10 ¹¹ ASTM stivity (Ω.cm) 10 ¹¹ ASTM activity (W/m.k) 3.5 ASTM HS PASS IEC 6 gen PASS EN14 | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.) 305mm x 305mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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EVSF100LFG is a tough,
wear-resistant, tensile-strength,
thermally conductive silicone pad
that is used to fill two
pressure-sensitive or vibrating
interfaces to allow air to escape
from the interface and improve
thermal conductivity. The product is
self-adhesive and can be die cut
into various shapes for easy
assembly. Thermal conductivity is
1.0W/MK.



Material Properties

- Semiconductor heat sink
- Vehicle navigator
- Communication & power equipment
- · Graphics card, memory module
- LED lighting equipment
- LCD and plasma TV



EVSF100FG

| Color | White | Visual |
|--------------------------------|--------------|------------|
| Thickness | 0.3 - 10.0mm | ASTM D374 |
| Specific Gravity | 2.2g/cc | ASTM D792 |
| Thermal Conductivity | 1.0 W/m-K | ASTM D5470 |
| Hardness (Shore OO) | 50-75 | ASTM D2240 |
| Elongation | 4% | ASTM D412 |
| Tensile Strength | 130psi | ASTM D412 |
| Electrical Strength | >200VAC/mil | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume resistivity | 7*1013Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@40psi) | 1.0°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 20% | |
| Dielectric Constant MHz | NA | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size

(Note: Other sheet sizes may be available upon request.)

200 x 300mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

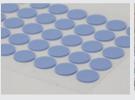
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CR Technology offers a wide variety of thermally conductive pads also known as gap fillers. These materials are available in both silicone and non-silicone formulations.

EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness, are naturally tacky and can be cut to any size or shape for easy installation





Material Properties

- · High thermal conductivity
- · Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVSF300

| Color | Gray | Visual |
|--------------------------------|---------------|------------|
| Thickness | 0.15 - 15.0mm | ASTM D374 |
| Specific Gravity | 2.3g/cc | ASTM D792 |
| Thermal Conductivity | 2.0 W/m-k | ASTM D5470 |
| Hardness(Shore oo) | 30-90 | ASTM D2240 |
| Elongation | 50% | ASTM D412 |
| Tensile Strength | 40psi | ASTM D412 |
| Electrical Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | |
| Volume resistivity | 1*1013Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@40psi) | 0.7°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@40psi) | 40% | |
| Dielectric Constant MHz | 6.0 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

200 x 300mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

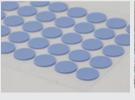
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EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness, are naturally tacky and can be cut to any size or shape for easy installation





Material Properties

- · High thermal conductivity
- · Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVSF400

| Color | Yellow | Visual |
|--------------------------------|--------------------|------------|
| Thickness | 0.15 - 10.0mm | ASTM D374 |
| Specific Gravity | 2.7g/cm3 | ASTM D792 |
| Thermal Conductivity | 2.50 W/mk | ASTM D5470 |
| Hardness(Shore oo) | 30-90 | ASTM D2240 |
| Normal Hardness(Shore00) | 40/60±5 | ASTM D2240 |
| Elongation | 40% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Electricial Strength | >8000V/mm | ASTM D149 |
| UL Flammability Rating | UL94 V-0 | E355606 |
| Volume resistivity | 1*1013Ω.cm | ASTM D257 |
| Operating Temperature | -50 - 200°C | |
| Thermal Resistance(1mm,@30psi) | 0.5°C*in2/W | ASTM D5470 |
| Compression Ratio(1mm,@30psi) | 30% | |
| Dielectric Constant@1 MHz | 7.0 | ASTM D150 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

200 x 300mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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EverTherm SH series is a highly sustainable and extremely versatile material. This product has uniform foam structure, excellent abrasion resilience, will not break down over time and is flame retardant. It can also be used for sound & heat insulation, moisture barrier, shock absorption, primarily for communications, electric vehicle (EV) power and electronics industries.



Material Properties

- Excellent flame retardancy
- Good electrical insulation
- Excellent elasticity high very low compression set
- Extreme temperature resistance, good sealing
- · Will not break down over time

Applications

- ✓ Communications,
- ✓ Electric Vehicle energy
- ✓ Electronics,
- ✓ Lighting equipment cabinet
- ✓ Hardware and other fields



EVSH600

| Parameter | Unit | Test Standard |
|--|-------------|--|
| Color | Visual | Gray |
| Thickness | mm | 1.0-12 |
| Density (25°C) | g/cm3 | 0.45 |
| Hardness | shore C | 5-85,Common 15/20 |
| Substrate | Silicone | |
| Compression deformation (maximum) | % | 70°C<1, 100°C<5 |
| Compression stress | 65kPa | ASTM D1056/compress 25% stress |
| Elongation | % | 80 |
| Flammability | UL94 | V-0 |
| Flame spread index | Ls | 25 |
| Vapor Density | Ds | Test in 4min < 50 Test in 1.5min < 20 |
| Toxic gas diffusion level | SMP-800C | PASS |
| Water absorption (Room temperature 24hr) | % | 1.4 |
| Dielectric constant | 1kHz | 1.42 |
| Dielectric strength | KV/mm | 3.58 |
| Dry arc resistance | s | 92 |
| Volume resistivity | Ω•cm | 1015 |
| Thermal conductivity | W/m.k | < 0.1 |
| Low temperature deflection (-55°C) | ASTM D 1056 | PASS |
| Recommend temperature | $^{\circ}$ | -55 ~ 220 |
| Recommended maximum temperature for intermittent use | $^{\circ}$ | 250 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| 0, 1, 10, 10; | 200 | 400 |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

300mm x 400mm

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Phase Change Material (PCM)

EverTherm PCM Series is very soft and shapeable and exhibits excellent thermal conductivity in the vertical (z-plane) direction. This material is a solid material at room temperature. When exposed to 50-55°C it becomes a soft semi-flowing paste. This allows easy shaping conformation between 2 compressed surfaces. The material will return back into solid state when it reaches below 50-55°C temperature. It can also be customized into different shapes and sizes based on the requirements of the application.





Material Properties

- •Excellent thermal conductivity in the vertical z-plane
- Strong interface wetting ability, long-term reliable thermal conductivity
- Good flexibility & compression ratio
- Effectively reduce the coating thickness of the material between the interface
- Flexible and can be easily converted to custom sizes
- Thin and lightweight

Applications

- Semiconductor device testing,
 CPU, GPU, MCM
 Mobile phones & PC tablets, PCs,
 Servers, and cloud storage
- Optical communications equipment, medical equipment
- ✓ Integrated Chip



EVSP205A

| | | 1 |
|-----------------------------------|---------------|----------------|
| Item | Detection | Testing method |
| Color | Gray | Visual |
| Thickness(mm) | 0.13mm | ASTM D751 |
| Thickness tolerance | ±0.015mm | ASTM D751 |
| Density/cm3) | 2.85 | ASTM D297 |
| Operating Temperature | -40°C - 125°C | *** |
| Phase change temperature | 50°C - 55°C | *** |
| Volume Resistance (Ω.cm) | 2.0 X 1010 | ASTM D257 |
| Thermal conductivity (W/m.K) | 3.0 | ASTM D5470 |
| Dielectric constant(1MHZ) | 3.0 | ASTM D150 |
| Thermal impedance@10psi(°C*in2/W) | 0.05 | ASTM D5470 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

305mm x 305mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Phase Change Material (PCM)

EverTherm PCM Series is very soft and shapeable and exhibits excellent thermal conductivity in the vertical (z-plane) direction. This material is a solid material at room temperature. When exposed to 50-55°C it becomes a soft semi-flowing paste. This allows easy shaping conformation between 2 compressed surfaces. The material will return back into solid state when it reaches below 50-55°C temperature. It can also be customized into different shapes and sizes based on the requirements of the application.



Material Properties

- •Excellent thermal conductivity in the vertical z-plane
- Strong interface wetting ability, long-term reliable thermal conductivity
- Good flexibility & compression ratio
- Effectively reduce the coating thickness of the material between the interface
- Flexible and can be easily converted to custom sizes
- Thin and lightweight

Applications

- Semiconductor device testing,
 CPU, GPU, MCM
 Mobile phones & PC tablets, PCs,
 Servers, and cloud storage
- ✓ PDP, LED devices, IGBT Modules
- Optical communications equipment, medical equipment
- ✓ Integrated Chip



EVSP350P

| Item | Detection | Testing metho |
|--|------------------|---------------|
| Color | Green | Visual |
| Reinforcement Carrier | ** | *** |
| Thickness (mm) | 0.20-0.50 | ASTM D374 |
| Elongation (%) | 40 | ASTM D882A |
| Tensile Strength (MPa) | 49 | ASTM D882A |
| Continuous Use Temp (°C) | 150 | *** |
| Phase Change Temp(℃) | 55 | ASTM D3418 |
| Dielectric Breakdown Voltage(Vac) | 8KV | ASTM D149 |
| Dielectric constant(1MHz) | 4.5 | ASTM D150 |
| Volume resistivity(Ω) | 10 ¹² | ASTM D257 |
| Thermal conductivity(W/m.k) | 1.8 | ASTM D5470 |
| Thermal Resistance (0.13mm,@10psi) 0.4 ^o C-in²/W | 0.4 | ASTM D5470 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size (Note: Other sheet sizes may be available upon request.)

305mm x 305mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Product Description
EverTherm EVSR600-A-B Graphite
Sheet is a synthetic graphite film
with a unique layered structure and
crystal orientation with
super-conductivity in the planar
direction. This high performing
versatile material is wrapped with a
white PET film which can be
converted or cut into various shapes.



Applications

- ✓ Applications
- ✓ Notebook / Laptop Computers
- √ TV
- ▼ Thermal module



EVSR600-A-B

| Item | Test | Test method |
|-----------------------------------|---------------------------------------|-------------|
| Protective film color | Black | Visual |
| Total thickness (mm) | 0.06±0.003 | ASTM D374 |
| Graphite substrate thickness (mm) | 0.025 | ASTM D374 |
| Ingredient | Black PET film Artificial graphite | *** |
| Insulating adhesive tape | Yes | *** |
| Density (g/cm3) | 1.7 - 2.0 | ASTM D792 |
| Thermal Conductivity @XY(W/m.k) | 1500 | ASTM E1461 |
| Thermal Conductivity @Z(W/m.k) | >30 | ASTM E1461 |
| Heat (J/g.k) | 0.85 | *** |
| Proper temperature (℃) | -40 to 130 | *** |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| Standard Sheet Size | 150 x 150mm | |

(Note: Other sheet sizes may be available upon request.)

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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EverTherm CS series is a composite material which offers extremely high thermal conductivity, low density and good durability. Carbon fiber is an anisotropic and offering a very high level of thermal conductivity in the Z axis. This silica gel sheet is very soft and well compressed, it is used to fill the interface of two substrates, ensuring air from the interface is discharged, and heat conduction dramatically improved. Thermal conductivity @ 25.0W/M.K



Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good flexibility and high compression ratio

Adhesive optional:

- -Al equals single-sided adhesive
- -A2 equals double-sided adhesive

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVCSF25

| Color | Black | Visual |
|----------------------------------|--------------|------------|
| Thickness | 0.5 - 20.0mm | ASTM D374 |
| Metal | Silicone | *** |
| Filler | Carbon Fiber | *** |
| Density | 2.9g/cm3 | ASTM D792 |
| Thermal Conductivity | 25.0W/m.k | ASTM D5470 |
| Dielectric Breakdown Voltageh@AC | 100V | ASTM D149 |
| Hardness (Shore 00) | 40-90 | ASTM D2240 |
| Normal Hardness(Shore00) | 40/60±5 | ASTM D2240 |
| Elongation | 30% | ASTM D412 |
| Tensile Strength | 30psi | ASTM D412 |
| Thermal Resistance(1mm,@40psi) | 0.06°C*in2/W | ASTM D5470 |
| Operating Temperature(℃) | -50 - 160°C | ASTM D1329 |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |
| | | |

Standard Sheet Size
(Note: Other sheet sizes may be available upon request.)

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

100 x 150mm

CR Technology, Inc

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EverTherm SY series is a new type of aerogel thermal insulation film which is a thin-film nano thermal insulation material. Aerogel is the world's lightest solid material offering the best thermal insulation performance. Its pore diameter is ~ 20nm, which is smaller than the free path of air (70nm). The air molecules in the pores lose their ability to flow freely, thus achieving ultra-high thermal insulation performance. In addition, by using the heat insulation film and the heat dissipation film in combination, the uniformity of the heat insulation can be improved. For related information, please consult the CR Technology technical team.





Material Properties

- Thin film: 80μm ~ 350 μm
- The combined use of heat dissipation film can provide a variety of thermal solutions.

Applications

- ✓ Wearable terminal
- **✓** LCD TV
- √ Tablet PC
- Digital cameras and various electronic devices that require heat insulation



EVSY300

| ltem | Detection | Testing method |
|---|------------------------|----------------|
| Thickness | 80µm ;130µm 350µm | ASTM D751 |
| Substrate (Base) | non | *** |
| Thermal conductivity (W/(m•K)) | 0.018 - 0.022 | ASTM D5470 |
| Operating temperature range (°C) | -20 - 120 | *** |
| Long-term heat resistance temperature (°C) | 120 | ASTM D2240 |
| Flame Rating | Not flame retardant | *** |
| Standard Sheet Size Note: Other sheet sizes may be available upon request. | 500mm x 25m | *** |
| RoHS | PASS | IEC 62321 |
| Halogen | PASS | EN14582 |
| REACH | PASS | EN14372 |

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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